



RoHS

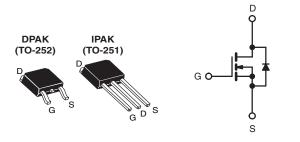
COMPLIANT

HALOGEN

FREE

### Power MOSFET

PRODUCT SUMMARY						
V <sub>DS</sub> (V)	100	100				
R <sub>DS(on)</sub> (Ω)	V <sub>GS</sub> = 5.0 V	V <sub>GS</sub> = 5.0 V 0.54				
Q <sub>g</sub> (Max.) (nC)	6.1	6.1				
Q <sub>gs</sub> (nC)	2.0	2.0				
Q <sub>gd</sub> (nC)	3.3	3.3				
Configuration	Sing	Single				



N-Channel MOSFET

#### **FEATURES**

- Halogen-free According to IEC 61249-2-21 **Definition**
- · Dynamic dV/dt Rating
- Repetitive Avalanche Rated
- Surface Mount (IRLR110, SiHLR110)
- Straight Lead (IRLU110, SiHLU110)
- Available in Tape and Reel
- Logic-Level Gate Drive
- R<sub>DS(on)</sub> Specified at V<sub>GS</sub> = 4 V and 5 V
- Compliant to RoHS Directive 2002/95/EC

#### **DESCRIPTION**

Third generation Power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The DPAK is designed for surface mounting using vapor phase, infrared, or wave soldering techniques. The straight lead version (IRLU, SiHLU series) is for through-hole mounting applications. Power dissipation levels up to 1.5 W are possible in typical surface mount applications.

ORDERING INFORMATION						
Package	DPAK (TO-252)	DPAK (TO-252)	DPAK (TO-252)	IPAK (TO-251)		
Lead (Pb)-free and Halogen-free	SiHLR110-GE3	SiHLR110TR-GE3	SiHLR110TRL-GE3	SiHLU110-GE3		
Lead (Pb)-free	IRLR110PbF	IRLR110TRPbFa	IRLR110TRLPbF	IRLU110PbF		
Lead (i b)-lifee	SiHLR110-E3	SiHLR110T-E3a	SiHLR110TL-E3	SiHLU110-E3		
SnPb	IRLR110	IRLR110TR <sup>a</sup>	IRLR110TRL <sup>a</sup>	IRLU110		
SIFD	SiHLR110	SiHLR110Ta	SiHLR110TLa	SiHLU110		

#### Note

a. See device orientation.

ABSOLUTE MAXIMUM RATINGS $T_{C}$	= 25 °C, unle	ess otherwis	e noted			
PARAMETER	SYMBOL	LIMIT	UNIT			
Drain-Source Voltage			$V_{DS}$	100	V	
Gate-Source Voltage			$V_{GS}$	± 10	7 v	
Continuous Drain Current	V <sub>GS</sub> at 5.0 V	T <sub>C</sub> = 25 °C T <sub>C</sub> = 100 °C	I_	4.3		
Continuous Drain Current	VGS at 5.0 V	T <sub>C</sub> = 100 °C	ID	2.7	Α	
Pulsed Drain Current <sup>a</sup>			I <sub>DM</sub>	17		
Linear Derating Factor				0.20	W/°C	
Linear Derating Factor (PCB Mount)e				0.020	VV/ C	
Single Pulse Avalanche Energy <sup>b</sup>			E <sub>AS</sub>	100	mJ	
Repetitive Avalanche Currenta			I <sub>AR</sub>	4.3	Α	
Repetitive Avalanche Energy <sup>a</sup>			E <sub>AR</sub>	2.5	mJ	
Maximum Power Dissipation $T_C = 25 ^{\circ}C$			Б	25	W	
Maximum Power Dissipation (PCB Mount)e T <sub>A</sub> = 25 °C			P <sub>D</sub>	2.5	7 vv	
Peak Diode Recovery dV/dtc			dV/dt	5.5	V/ns	
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stg</sub>	- 55 to + 150	°C		
Soldering Recommendations (Peak Temperature)	for	10 s		260 <sup>d</sup>	1	

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b.  $V_{DD}=25$  V, starting  $T_J=25$  °C, L=8.1 mH,  $R_g=25$   $\Omega$ ,  $I_{AS}=4.3$  A (see fig. 12). c.  $I_{SD}\leq 5.6$  A, dI/dt  $\leq 140$  A/ $\mu$ s,  $V_{DD}\leq V_{DS}$ ,  $T_J\leq 150$  °C.
- d. 1.6 mm from case.
- e. When mounted on 1" square PCB (FR-4 or G-10 material).

<sup>\*</sup> Pb containing terminations are not RoHS compliant, exemptions may apply

# IRLR110, IRLU110, SiHLR110, SiHLU110

# Vishay Siliconix



THERMAL RESISTANCE RATINGS							
PARAMETER	SYMBOL	MIN.	TYP.	MAX.	UNIT		
Maximum Junction-to-Ambient	R <sub>thJA</sub>	-	-	110			
Maximum Junction-to-Ambient (PCB Mount) <sup>a</sup>	R <sub>thJA</sub>	-	-	50	°C/W		
Maximum Junction-to-Case (Drain)	R <sub>thJC</sub>	-	-	5.0			

#### Note

a. When mounted on 1" square PCB (FR-4 or G-10 material).

<b>SPECIFICATIONS</b> T <sub>J</sub> = 25 °C, ur			T CONDITIONS				
PARAMETER	SYMBOL	TES	MIN.	TYP.	MAX.	UNIT	
Static					T		
Drain-Source Breakdown Voltage	$V_{DS}$		= 0 V, I <sub>D</sub> = 250 μA	100	-	-	V
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	e to 25 °C, I <sub>D</sub> = 1 mA	-	0.12	-	V/°C
Gate-Source Threshold Voltage	$V_{GS(th)}$	$V_{DS} =$	$V_{GS}$ , $I_{D} = -250 \mu A$	1.0	-	2.0	V
Gate-Source Leakage	$I_{GSS}$	,	$V_{GS} = \pm 10 \text{ V}$	-	-	± 100	nA
Zero Gate Voltage Drain Current	1	V <sub>DS</sub> =	$= 100 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$	-	-	25	μA
Zero Gate Voltage Drain Gurrent	I <sub>DSS</sub>	$V_{DS} = 80 \text{ V}$	, $V_{GS} = 0 \text{ V}$ , $T_{J} = 125  ^{\circ}\text{C}$	-	-	250	μΑ
Drain-Source On-State Resistance	В	$V_{GS} = 5.0 \text{ V}$	$I_D = 2.6 A^b$	-	-	0.54	
Drain-Source On-State Resistance	$R_{DS(on)}$	V <sub>GS</sub> = 4.0 V	I <sub>D</sub> = 2.2 A <sup>b</sup>	-	-	0.76	Ω
Forward Transconductance	9 <sub>fs</sub>	V <sub>DS</sub>	= 50 V, I <sub>D</sub> = 2.6 A	2.3	-	-	S
Dynamic							
Input Capacitance	C <sub>iss</sub>	$V_{GS} = 0 \text{ V},$ $V_{DS} = 25 \text{ V},$ $f = 1.0 \text{ MHz}, \text{ see fig. 5}$		-	250	-	pF
Output Capacitance	C <sub>oss</sub>			-	80	-	
Reverse Transfer Capacitance	C <sub>rss</sub>			-	15	-	
Total Gate Charge	Qg	$V_{GS} = 5.0 \text{ V}$ $I_D = 5.6 \text{ A}, V_{DS} = 80 \text{ V},$ see fig. 6 and 13 <sup>b</sup>		-	-	6.1	nC
Gate-Source Charge	Q <sub>gs</sub>			-	-	2.0	
Gate-Drain Charge	Q <sub>gd</sub>			-	-	3.3	
Turn-On Delay Time	t <sub>d(on)</sub>			-	9.3	-	
Rise Time	t <sub>r</sub>	V <sub>DD</sub> =	= 50 V, I <sub>D</sub> = 5.6 A,	-	47	-	]
Turn-Off Delay Time	t <sub>d(off)</sub>	$R_g = 12 \Omega$ , $R_D = 8.4 \Omega$ , see fig. $10^b$		-	16	-	ns
Fall Time	t <sub>f</sub>	1		-	17	-	
Internal Drain Inductance	L <sub>D</sub>	Between lead, 6 mm (0.25") from		-	4.5	-	
Internal Source Inductance	L <sub>S</sub>	package and center of die contact <sup>c</sup>		-	7.5	-	nH
Drain-Source Body Diode Characteristic	s			•		•	
Continuous Source-Drain Diode Current	I <sub>S</sub>	MOSFET symbol showing the integral reverse p - n junction diode		-	-	4.3	_
Pulsed Diode Forward Current <sup>a</sup>	I <sub>SM</sub>			-	-	17	A
Body Diode Voltage	$V_{SD}$	T <sub>J</sub> = 25 °C	C, I <sub>S</sub> =4.3 A, V <sub>GS</sub> = 0 V <sup>b</sup>	-	-	2.5	V
Body Diode Reverse Recovery Time	t <sub>rr</sub>	T 05.00 :	E O A 41/41 400 A / h	-	100	130	ns
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>	$I_J = 25 \text{ °C, } I_F$	$= 5.6 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}^{\text{b}}$	-	0.50	0.65	μC
Forward Turn-On Time	t <sub>on</sub>	Intrinsic tu	-on is dor	ninated b	v L and	1-7	

#### Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b. Pulse width  $\leq$  300  $\mu$ s; duty cycle  $\leq$  2 %.

#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

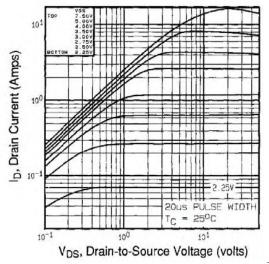


Fig. 1 - Typical Output Characteristics,  $T_C = 25$  °C

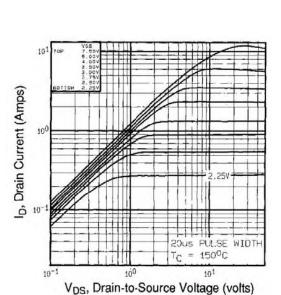


Fig. 2 - Typical Output Characteristics,  $T_C$  = 150  $^{\circ}C$ 

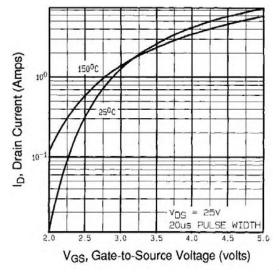


Fig. 3 - Typical Transfer Characteristics

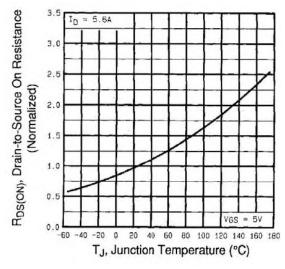


Fig. 4 - Normalized On-Resistance vs. Temperature

# IRLR110, IRLU110, SiHLR110, SiHLU110

# Vishay Siliconix



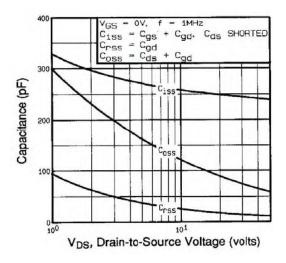


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

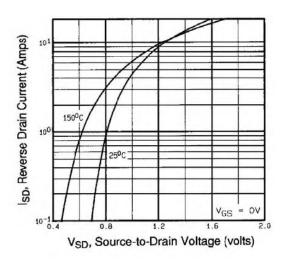


Fig. 7 - Typical Source-Drain Diode Forward Voltage

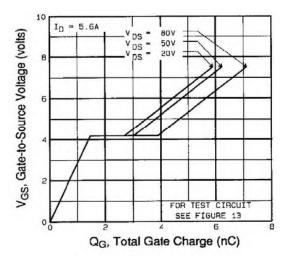


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

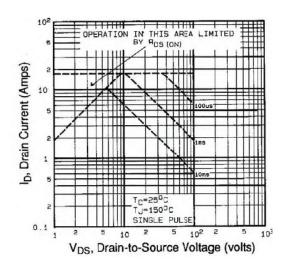


Fig. 8 - Maximum Safe Operating Area





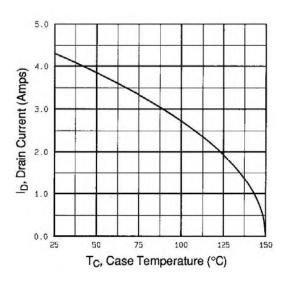


Fig. 9 - Maximum Drain Current vs. Case Temperature

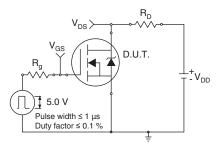


Fig. 10a - Switching Time Test Circuit

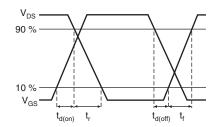


Fig. 10b - Switching Time Waveforms

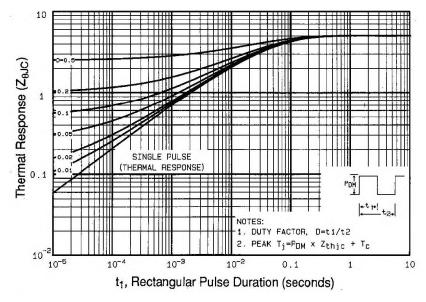


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case



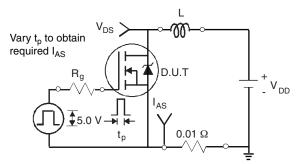


Fig. 12a - Unclamped Inductive Test Circuit

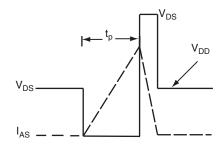


Fig. 12b - Unclamped Inductive Waveforms

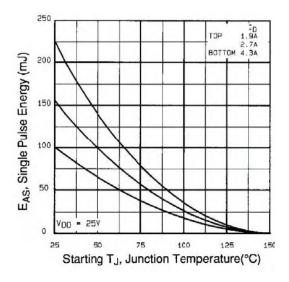


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

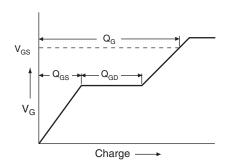


Fig. 13a - Basic Gate Charge Waveform

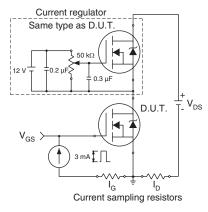
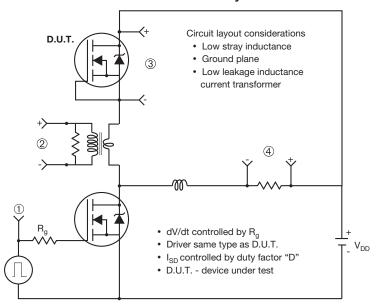


Fig. 13b - Gate Charge Test Circuit

#### Peak Diode Recovery dV/dt Test Circuit



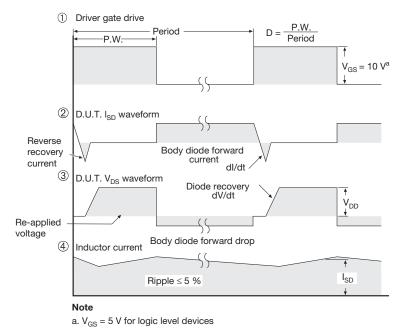
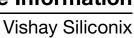


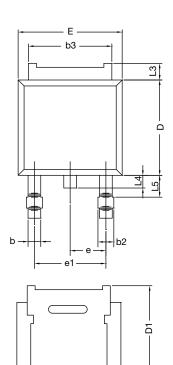
Fig. 14 - For N-Channel

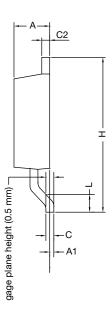
Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see <a href="https://www.vishay.com/ppg?91323">www.vishay.com/ppg?91323</a>.





### **TO-252AA Case Outline**





	MILLIN	METERS	INC	HES
DIM.	MIN.	MAX.	MIN.	MAX.
Α	2.18	2.38	0.086	0.094
A1	-	0.127	-	0.005
b	0.64	0.88	0.025	0.035
b2	0.76	1.14	0.030	0.045
b3	4.95	5.46	0.195	0.215
С	0.46	0.61	0.018	0.024
C2	0.46	0.89	0.018	0.035
D	5.97	6.22	0.235	0.245
D1	4.10	-	0.161	-
Е	6.35	6.73	0.250	0.265
E1	4.32	-	0.170	-
Н	9.40	10.41	0.370	0.410
e	2.28 BSC		0.090	BSC
e1	4.56	BSC	0.180	BSC
L	1.40	1.78	0.055	0.070
L3	0.89	1.27	0.035	0.050
L4	-	1.02	-	0.040
L5	1.01	1.52	0.040	0.060
ECN: T16-0236-Rev. P, 16-May-16				

### DWG: 5347 Notes

• Dimension L3 is for reference only.



### **TO-251AA (HIGH VOLTAGE)**



Section B - B and C - C

	MILLIN	METERS	INC	HES
DIM.	MIN.	MAX.	MIN.	MAX.
Α	2.18	2.39	0.086	0.094
A1	0.89	1.14	0.035	0.045
b	0.64	0.89	0.025	0.035
b1	0.65	0.79	0.026	0.031
b2	0.76	1.14	0.030	0.045
b3	0.76	1.04	0.030	0.041
b4	4.95	5.46	0.195	0.215
С	0.46	0.61	0.018	0.024
c1	0.41	0.56	0.016	0.022
c2	0.46	0.86	0.018	0.034
D	5.97	6.22	0.235	0.245

	MILLIN	IETERS	INC	HES
DIM.	MIN.	MAX.	MIN.	MAX.
D1	5.21	-	0.205	-
Е	6.35	6.73	0.250	0.265
E1	4.32	-	0.170	-
е	2.29 BSC		2.29	BSC
L	8.89	9.65	0.350	0.380
L1	1.91	2.29	0.075	0.090
L2	0.89	1.27	0.035	0.050
L3	1.14	1.52	0.045	0.060
θ1	0'	15'	0'	15'
θ2	25'	35'	25'	35'

ECN: S-82111-Rev. A, 15-Sep-08

DWG: 5968

#### Notes

- 1. Dimensioning and tolerancing per ASME Y14.5M-1994.
- 2. Dimension are shown in inches and millimeters.
- 3. Dimension D and E do not include mold flash. Mold flash shall not exceed 0.13 mm (0.005") per side. These dimensions are measured at the outermost extremes of the plastic body.
- 4. Thermal pad contour optional with dimensions b4, L2, E1 and D1.
- 5. Lead dimension uncontrolled in L3.
- 6. Dimension b1, b3 and c1 apply to base metal only.
- 7. Outline conforms to JEDEC outline TO-251AA.

Document Number: 91362 Revision: 15-Sep-08



### **RECOMMENDED MINIMUM PADS FOR DPAK (TO-252)**



Recommended Minimum Pads Dimensions in Inches/(mm)

Return to Index

APPLICATION NOTE



### **Legal Disclaimer Notice**

Vishay

### **Disclaimer**

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and/or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Except as expressly indicated in writing, Vishay products are not designed for use in medical, life-saving, or life-sustaining applications or for any other application in which the failure of the Vishay product could result in personal injury or death. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.

### **Material Category Policy**

Vishay Intertechnology, Inc. hereby certifies that all its products that are identified as RoHS-Compliant fulfill the definitions and restrictions defined under Directive 2011/65/EU of The European Parliament and of the Council of June 8, 2011 on the restriction of the use of certain hazardous substances in electrical and electronic equipment (EEE) - recast, unless otherwise specified as non-compliant.

Please note that some Vishay documentation may still make reference to RoHS Directive 2002/95/EC. We confirm that all the products identified as being compliant to Directive 2002/95/EC conform to Directive 2011/65/EU.

Vishay Intertechnology, Inc. hereby certifies that all its products that are identified as Halogen-Free follow Halogen-Free requirements as per JEDEC JS709A standards. Please note that some Vishay documentation may still make reference to the IEC 61249-2-21 definition. We confirm that all the products identified as being compliant to IEC 61249-2-21 conform to JEDEC JS709A standards.

Revision: 02-Oct-12 Document Number: 91000

# **Mouser Electronics**

**Authorized Distributor** 

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

### Vishay:

IRLR110TRPBF IRLR110TRLPBF IRLU110PBF IRLR110 IRLR110TR IRLR110TRL IRLU110 IRLR110PBF